

Low frequency transistor(-12V, -500mA)

| Parameter | Value | |
|------------------|--------|--|
| V _{CEO} | -12V | |
| IC | -500mA | |

Features

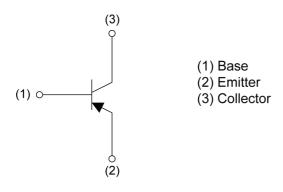
- 1)High current.
- 2)Collector-Emitter saturation voltage is low. V_{CE(sat)}≤250mA at I_C=-200mA/I_B=-10mA

Application

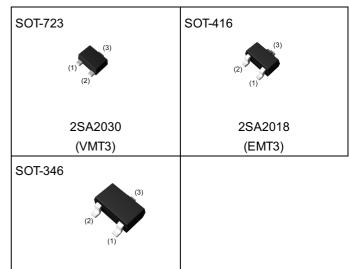
LOW FREQUENCY AMPLIFIER, DRIVER

•Inner circuit

2SA2030



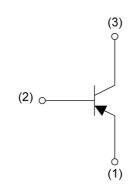
Outline



2SA2018/2SA2119K

2SA2119K

(SMT3)



- (1) Emitter
- (2) Base
- (3) Collector

Packaging specifications

| Part No. | Package | Package size | Taping code | Reel size (mm) | Tape width (mm) | Basic ordering unit.(pcs) | Marking |
|----------|-------------------|-----------------|----------------|-------------------|-----------------|---------------------------------|---------|
| 2SA2030 | SOT-723 (VMT3) | 1212 | T2L | 180 | 8 | 8000 | BW |
| 2SA2018 | SOT-416 (EMT3) | 1616 | TL | 180 | 8 | 3000 | BW |
| 2SA2119K | SOT-346 (SMT3) | 2928 | T146 | 180 | 8 | 3000 | BW |

● Absolute maximum ratings (T_a = 25°C)

| Parameter | | | Values | Unit |
|------------------------------|----------------|--------------------|-------------|------|
| Collector-base voltage | | | -15 | V |
| Collector-emitter voltage | | | -12 | V |
| Emitter-base voltage | | | -6 | V |
| 0-11 | I _C | -500 | mA | |
| Collector current | | I _{CP} *1 | -1 | А |
| | 2SA2030 | | 150 | |
| Power dissipation | 2SA2018 | P _D *2 | 150 | mW |
| 2SA2119K | | | 200 | |
| Junction temperature | | | 150 | °C |
| Range of storage temperature | | | -55 to +150 | °C |

● Electrical characteristics (T_a = 25°C)

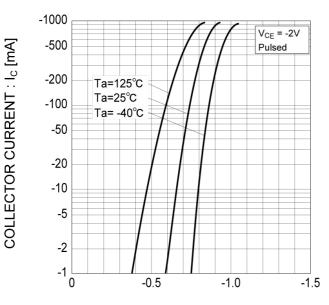
| Davanastav | Curah al | Conditions | Values | | | l leit | |
|--------------------------------------|----------------------|--|--------|------|------|--------|--|
| Parameter | Symbol | Symbol Conditions — | | Тур. | Max. | Unit | |
| Collector-base breakdown voltage | BV _{CBO} | I _C = -10μA | -15 | - | - | V | |
| Collector-emitter breakdown voltage | BV _{CEO} | I _C = -1mA | -12 | - | - | V | |
| Emitter-base breakdown voltage | BV _{EBO} | I _E = -10μA | 6 | 1 | - | V | |
| Collector cut-off current | I _{CBO} | V _{CB} = -15V | 1 | - | -100 | nA | |
| Emitter cut-off current | I _{EBO} | V _{EB} = -6V | 1 | - | -100 | nA | |
| Collector-emitter saturation voltage | V _{CE(sat)} | I _C = -200mA, I _B = -10mA | ı | -100 | -250 | mV | |
| DC current gain | h _{FE} | $V_{CE} = -2V, I_{C} = -10mA$ | 270 | 1 | 680 | - | |
| Transition frequency | f _T | $V_{CE} = -2V, I_{E} = 10mA,$ f = 100MHz | - | 260 | - | MHz | |
| Output capacitance | C _{ob} | V _{CB} = -10V, I _E = 0A, f = 1MHz | - | 6.5 | - | pF | |

^{*1} Pw=1ms, Single Pulse.

^{*2} Each terminal mounted on a reference land.

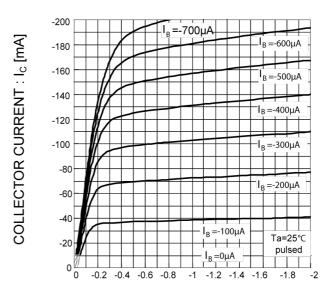
● Electrical characteristic curves(T_a = 25°C)

Fig.1 Ground Emitter Propagation Characteristics



BASE TO EMITTER VOLTAGE : $V_{\text{BE}}\left[V\right]$

Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V_{CE} [V]

Fig.3 DC Current Gain vs. Collector Current (I)

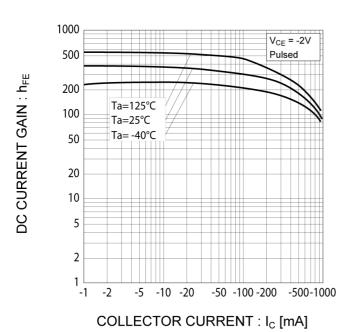
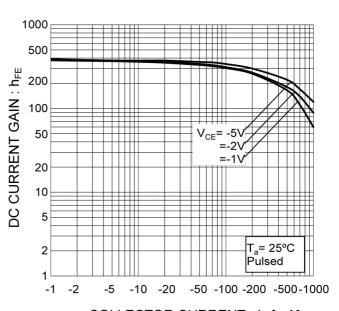


Fig.4 DC Current Gain vs. Collector Current (II)



COLLECTOR CURRENT : I_C [mA]

● Electrical characteristic curves(T_a = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current (I)

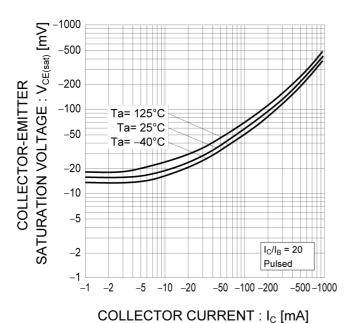
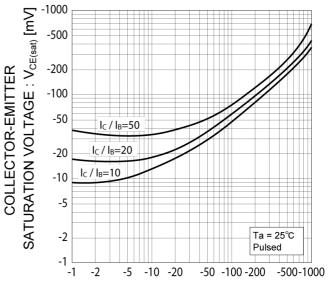


Fig.6 Collector-Emitter Saturation
Voltage vs. Collector Current (II)



COLLECTOR CURRENT: Ic [mA]

Fig.7 Base-Emitter Saturation Voltage vs.
Collector Current

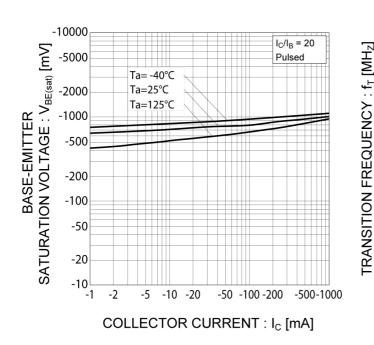
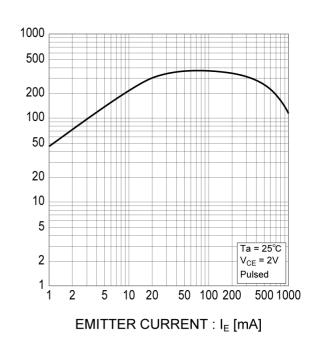


Fig.8 Gain Bandwidth Product vs.
Emitter Current



● Electrical characteristic curves(T_a = 25°C)

Fig.9 Emitter Input Capacitance vs.
Emitter-Base Voltage
Collector Output Capacitance vs.
Collector-Base Voltage

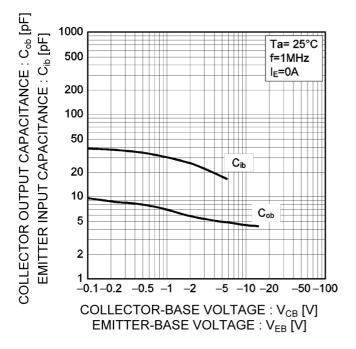


Fig.10 Safe Operating Area (I)

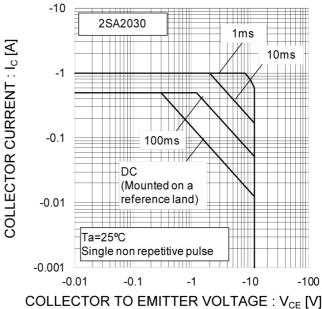


Fig.11 Safe Operating Area (II)

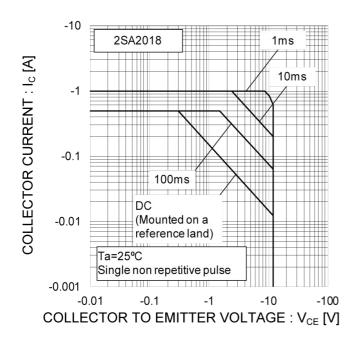
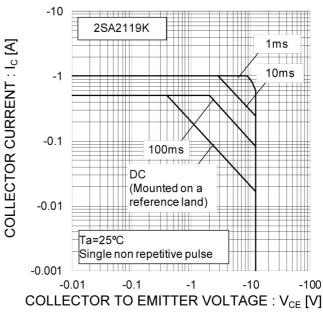
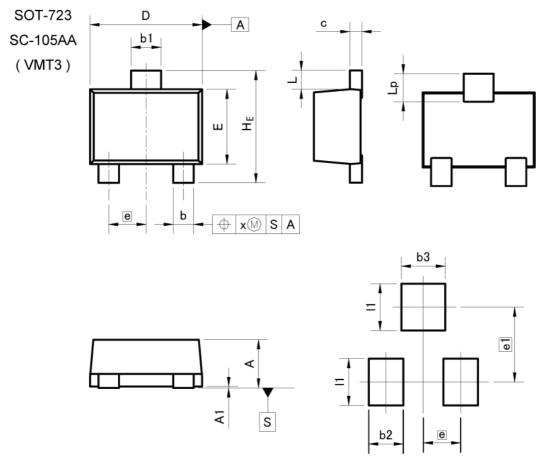


Fig.12 Safe Operating Area (III)



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

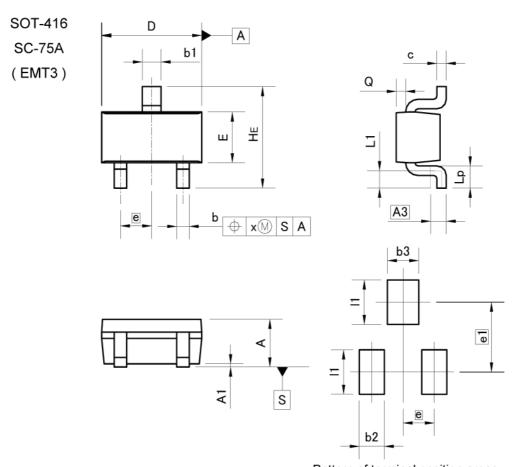
| DIM | MILIM | ETERS | INC | HES |
|-----|-------|-------|-------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 0.45 | 0.55 | 0.018 | 0.022 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| b | 0.17 | 0.27 | 0.007 | 0.011 |
| b1 | 0.27 | 0.37 | 0.011 | 0.015 |
| С | 0.08 | 0.18 | 0.003 | 0.007 |
| D | 1.10 | 1.30 | 0.043 | 0.051 |
| E | 0.70 | 0.90 | 0.028 | 0.035 |
| е | 0.4 | 40 | 0.02 | |
| HE | 1.10 | 1.30 | 0.043 | 0.051 |
| L | 0.10 | 0.30 | 0.004 | 0.012 |
| Lp | 0.20 | 0.40 | 0.008 | 0.016 |
| Х | - | 0.10 | _ | 0.004 |

| DIM | MILIM | ETERS | INCHES | |
|-----|-------|-------|--------|-------|
| | MIN | MAX | MIN | MAX |
| b2 | - | 0.37 | _ | 0.015 |
| b3 | _ | 0.47 | 7- | 0.019 |
| e1 | 0.80 | | 0.0 | 31 |
| 11 | - | 0.50 | | 0.020 |

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

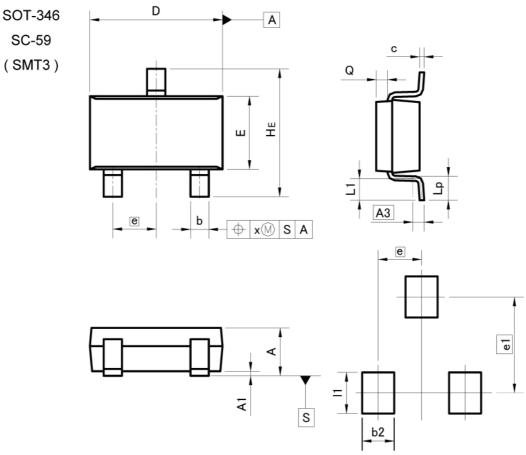
| DIM | MILIM | ETERS | INC | HES |
|-----|-------|-------|----------------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 0.60 | 0.80 | 0.024 | 0.031 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| A3 | 0. | 25 | 0.0 | 10 |
| b | 0.15 | 0.30 | 0.006 | 0.012 |
| b1 | 0.25 | 0.40 | 0.010 | 0.016 |
| С | 0.10 | 0.20 | 0.004 | 0.008 |
| D | 1.50 | 1.70 | 0.059 | 0.067 |
| E | 0.70 | 0.90 | 0.028 | 0.035 |
| е | 0. | 50 | 0.0 | 20 |
| HE | 1.40 | 1.80 | 0.055 | 0.071 |
| L1 | 0.10 | - | 0.004 | - |
| Lp | 0.15 | - | 0.006 | £= |
| Q | 0.05 | 0.25 | 0.002 | 0.010 |
| × | - | 0.10 | , - | 0.004 |

| DIM | MILIMETERS | | INCHES | |
|-----|------------|------|--------|-------|
| DIM | MIN | MAX | MIN | MAX |
| b2 | 1 | 0.40 | - | 0.016 |
| b3 | I | 0.50 | - | 0.020 |
| e1 | 1.10 | | 0.0 | 43 |
| l1 | 1= | 0.70 | | 0.028 |

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

| DIM | MILIM | ETERS | INC | HES |
|-----|-------|-------|-------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 1.00 | 1.30 | 0.039 | 0.051 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| A3 | 0.3 | 25 | 0.0 | 10 |
| b | 0.35 | 0.50 | 0.014 | 0.020 |
| С | 0.09 | 0.25 | 0.004 | 0.010 |
| D | 2.80 | 3.00 | 0.110 | 0.118 |
| E | 1.50 | 1.80 | 0.059 | 0.071 |
| е | 0.9 | 95 | 0.037 | |
| HE | 2.60 | 3.00 | 0.102 | 0.118 |
| L1 | 0.30 | 0.60 | 0.012 | 0.024 |
| Lp | 0.40 | 0.70 | 0.016 | 0.028 |
| Q | 0.20 | 0.30 | 0.008 | 0.012 |
| х | - | 0.10 | e= | 0.004 |
| у | - > | 0.10 | - | 0.004 |

| | DIM | MILIMETERS | | INCHES | |
|--|-----|------------|------|--------|-------|
| | | MIN | MAX | MIN | MAX |
| | b2 | - | 0.60 | _ | 0.024 |
| | e1 | 2.10 | | 0.0 | 83 |
| | 11 | ľ | 0.90 | - | 0.035 |

Dimension in mm/inches



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| JAPAN | USA | EU | CHINA |
|---------|----------|------------|-----------|
| CLASSⅢ | CLASSⅢ | CLASS II b | CL ACCIII |
| CLASSIV | CLASSIII | CLASSⅢ | CLASSIII |

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
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- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина,

дом 2, корпус 4, литера А.